Experimental and Spectral Finite Element Study of Plates with Shunted Piezoelectric Patches

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The need for passive damping techniques arises from the complexities, added weight, and energy requirements associated with the implementation of various active control techniques. A novel passive damping approach for the attenuation and localisation of the vibration of plates is presented in this study. The introduction of distributed piezoelectric patches with passively shunted circuits is presented. A numerical model that describes the coupling of a shunted circuit with flexible plates is developed using a spectral finite element approach. The prediction of the model is validated against analytical and experimental results. The numerical and experimental results obtained demonstrate the feasibility of using piezoelectric patches with passive shunting as an effective means for damping out the plate vibration. Furthermore, it is shown that the proposed approach is capable of producing broadband attenuation and localisation of the vibration by introducing disorder into the passive shunting circuits.

Nomenclature

A	– Area	
a;	- Undetermined coefficients of the transverse	μ 0
1	displacement shape function	σ
b_i	- Undetermined coefficients of the electric dis-	θ
	placement shape function	v
D	– Electric displacement	ω
D_P	– Plate flexural rigidity	e
d	 Piezoelectric coefficient 	θ
d_i	 Nodal electric displacement 	~
Ε	 Young's modulus of elasticity 	Su
Ē	– Electric field	D
е	- Piezoelectric material constant relating stress to	w
	electric field	b
H_w, H_D	- Transverse displacement and electric displace-	x
	ment interpolation functions respectively	,х
$k, k_x k_y$	- Wave number, component of wave number in x	У
	and y-directions respectively	,y
k_b, k_D, k_{bD}	 Element bending, electric, and displacement- electric coupling stiffness matrices respectively 	Su
m_b, m_D	- Element bending and electric mass matrices re-	D
	spectively	Ē
N_w, N_D	- Lateral displacement and electric displacement	Т
	shape functions respectively	
Q	- Plane stress plane strain constitutive relation	1.
Т	– Kinetic energy	
U	 Potential energy 	1
V	– Volume	1.
W	– External work	
W	 Transverse displacement 	Le
w_b, w_D	- Nodal transverse and electric displacements re-	inc
	spectively	ph
$\beta = 1/\epsilon$		tor
$\delta(\cdot)$	 First variation 	are
3	– Strain	an

γ_{xy}	 Shear strain
κ	– Curvature
μ	 The propagation constant
ρ	 Mass density
σ	- Stress
θ	– Wave propagation angle
v	– Poisson's ratio
ω	– Frequency

- Here Phase angle

Subscripts

- D Related to electric degrees of freedom
- Related to transverse deflection
- Related to bending degrees of freedom
- x -In the *x*-direction
- x Derivative in the x-direction
- In the y-direction
- y Derivative in the y-direction

Superscript

- D At constant electric displacement
- \bar{E} At constant electric field
- T Matrix transpose

. INTRODUCTION

1.1. Passively Shunted Piezoelectrics

In a review article about shunted piezoelectric elements, Lesieutre¹ presented a classification of shunted circuits into inductive, resistive, capacitive, and switched circuits. He emphasised that the inductive circuits, which include an inductor and a resistance in parallel with the piezo-capacitor (Fig. 1), are the most widely used circuits in damping as they are analogous to a mechanical vibration absorber.